20

40

60

80

100

Packaging

D

в

0.1

Insertion Loss (dB)

2R1H

471R1H3

12100

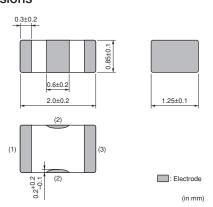
Packaging

180mm Paper Tape

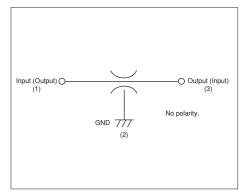
Bulk(Bag)

Data Sheet

# EMIFIL® (Capacitor type) Single Circuit Type for Signal Lines NFM21C Series (0805 Size) Dimensions Insertion Loss Characteristics (Main Items)



## Equivalent Circuit



#### ■ Rated Value (□: packaging code)

Part Number	Capacitance	Rated Current	Rated Voltage	Insulation Resistance (min.)	Operating Temperature Range
NFM21CC220U1H3	22pF ±20%	700mA	50Vdc	1000M ohm	-55 to +125°C
NFM21CC470U1H3	47pF ±20%	700mA	50Vdc	1000M ohm	-55 to +125°C
NFM21CC101U1H3	100pF ±20%	700mA	50Vdc	1000M ohm	-55 to +125°C
NFM21CC221R1H3	220pF ±20%	700mA	50Vdc	1000M ohm	-55 to +125°C
NFM21CC471R1H3	470pF ±20%	1000mA	50Vdc	1000M ohm	-55 to +125°C
NFM21CC102R1H3	1000pF ±20%	1000mA	50Vdc	1000M ohm	-55 to +125°C
NFM21CC222R1H3	2200pF ±20%	1000mA	50Vdc	1000M ohm	-55 to +125°C
NFM21CC223R1H3	22000pF ±20%	2000mA	50Vdc	1000M ohm	-55 to +125°C

Number of Circuit: 1

Continued on the following page.

6000

Minimum Quantity

4000

500

1000

100

Frequency (MHz)

•This data sheet is applied for CHIP EMIFIL<sup>®</sup> used for General Electronics equipment for your design.

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2. This datasheet has only typical specifications because there is no space for detailed specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.



Data Sheet

#### Continued from the preceding page.

### ■ ①Caution/Notice

#### 

Do not use products beyond the rated current and rated voltage as this may create excessive heat and deteriorate the insulation resistance.

#### Notice

Solderability of Tin plating termination chip might be deteriorated when low temperature soldering profile where peak solder temperature is below the Tin melting point is used. Please confirm the solderability of Tin plating termination chip before use. 2

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